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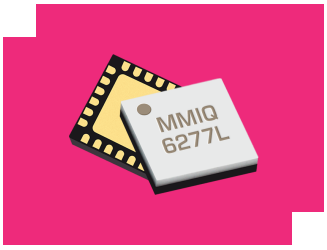
MMIQ-0626LSM-2

Surface Mount MMIC IQ Mixer

DEVICE OVERVIEW

General Description

The MMIQ-0626LSM is a passive GaAs MMIC IQ mixer. This is an ultra-broadband mixer spanning 6 to 26GHz on the RF and LO ports with an IF from DC to 6 GHz. Up to 40 dB of image rejection is available due to the excellent phase and amplitude balance of its on-chip LO quadrature hybrid. Banded performance is possible at lower LO drives. Both surface QFNs and evaluation boards are available.



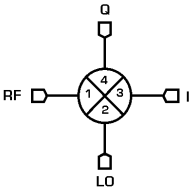
Features

RF/LO Frequency Range: 6 - 26 GHz
IF Frequency Range: DC - 6 GHz
I+Q Conversion Loss: 9 dB
Image Rejection: 35 dB
LO-RF Isolation: 39 dB

Applications

- Single Sideband and Image Rejection Mixing
- IQ Modulation / Demodulation
- Vector Signal Modulation and Demodulation
- Band Shifting

Functional Block Diagram



Part Ordering Options

Part Number	Description	Package	Packing Size	Green Status	Product Lifecycle	Export Classification
MMIQ-0626LSM-2	Surface Mount MMIC IQ Mixer	QFN	-	RoHS	Released	EAR99
EVAL-MMIQ-0626L	Evaluation Board, Surface Mount MMIC 6-26 GHz IQ Mixer	-	-	Non-RoHS	Released	EAR99

Table Of Contents

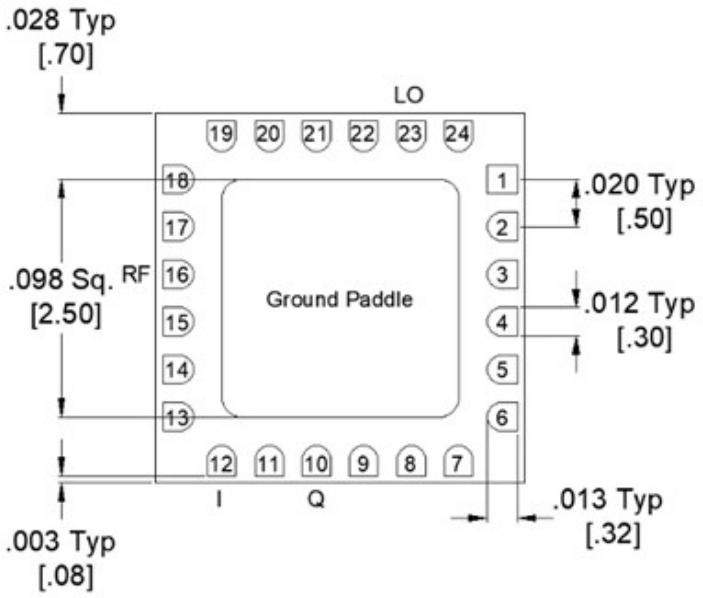
Revision History

Revision Code	Revision Date	Comment
-	2012-03-01	Datasheet Initial Release
A	2019-08-01	Changed I/Q Max Current Rating
B	2019-10-01	Updated Max Power Rating
C	2022-02-01	I/Q Port Functions, Plots, ESD Updated

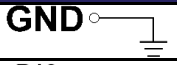
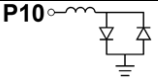
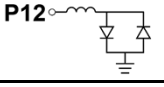
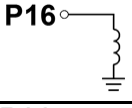
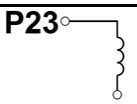
Port Configuration and Functions

Port Diagram

A bottom-up view of the MMIQ-0626L's SM package outline drawing is shown below. The mixer may be operated as either a downconverter or an upconverter. Use of the RF or IF as the input or output port will depend on the application.



Port Functions

Port	Function	Description	Equivalent Circuit for Package
GND	Ground	SM package ground path is provided through the ground paddle.	
Pin 10	Q Input / Output	Port 3 is diode coupled and AC matched to 50Ω over the specified Q port frequency range.	
Pin 12	I Input / Output	Port 4 is diode coupled and AC matched to 50Ω over the specified I port frequency range.	
Pin 16	RF Input / Output	Port 1 is DC short and AC matched to 50Ω over the specified RF frequency range.	
Pin 23	LO Input	Port 2 is DC open and AC matched to 50Ω over the specified LO frequency range.	

Specifications

Absolute Maximum Ratings

The Absolute Maximum Ratings indicate limits beyond which damage may occur to the device. If these limits are exceeded, the device may be inoperable or have a reduced lifetime.

Parameter	Maximum Rating	Unit
Maximum Operating Temperature	100	°C
Maximum Storage Temperature	125	°C
Minimum Operating Temperature	-55	°C
Minimum Storage Temperature	-65	°C
Pin 10 DC Current	30	mA
Pin 12 DC Current	30	mA
Power Handling, at any Port	26	dBm

Package Information

Parameter	Details	Rating
ESD	250 to < 500 Volts	HBM Class 1A
Weight	Package name: QFN	13.4g
Dimensions	-	4x4 mm

Recommended Operating Conditions

The Recommended Operating Conditions indicate the limits, inside which the device should be operated, to guarantee the performance given in Electrical Specifications. Operating outside these limits may not necessarily cause damage to the device, but the performance may degrade outside the limits of the electrical specifications. For limits, above which damage may occur, see Absolute Maximum Ratings.

Parameter	Min	Nominal	Max	Unit
LO Input Power	11	15	20	dBm
RF/IF Input Power	-	-	6	dBm
Ambient Temperature	-55	25	100	°C

Sequencing Requirements

There is no requirement to apply power to the ports in a specific order. However, it is recommended to provide a 50Ω termination to each port before applying power. This is a passive diode mixer that requires no DC bias.

Electrical Specifications

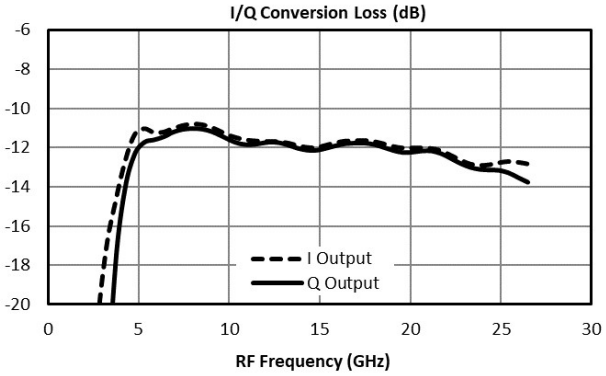
The electrical specifications apply at TA=+25°C in a 50Ω system. Typical data shown is for a down conversion application with a +15dBm sine wave LO input. Min and Max limits apply only to our connectorized units and are guaranteed at TA=+25°C.

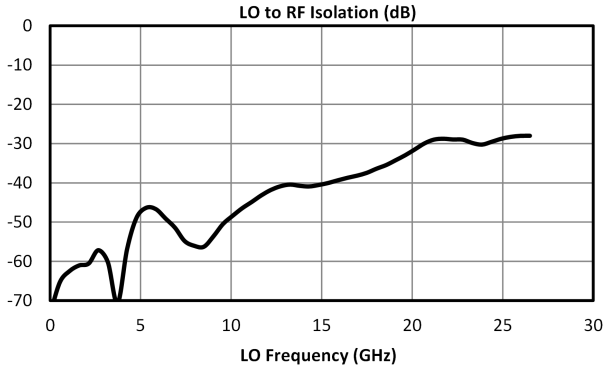
Parameter	Test Conditions	Minimum Frequency (GHz)	Maximum Frequency (GHz)	Min	Typ	Max	Unit
RF Frequency Range	-	-	-	6	-	26	GHz
LO Frequency Range	-	-	-	6	-	26	GHz
Conversion Loss [1]	RF/LO = 6 - 24 GHz I = DC -0.2 GHz	6	24	-	12	15	dB
Conversion Loss [2]	RF/LO = 6 - 24 GHz Q = DC – 0.2 GHz	6	24	-	12	15	dB
Conversion Loss [3]	RF/LO = 6 - 26 GHz I = 0.2 - 6 GHz	6	26	-	14	-	dB
Conversion Loss [4]	RF/LO = 6 - 26 GHz Q = 0.2 - 6 GHz	6	26	-	14	-	dB
Conversion Loss [5]	RF/LO = 24 - 26 GHz I = DC - 0.2 GHz	24	26	-	12	15	dB
Conversion Loss [6]	RF/LO = 24 - 26 GHz Q = DC – 0.2 GHz	24	26	-	14	17	dB
Noise Figure [7]	RF/LO = 6 - 24 GHz I = DC – 0.2 GHz	6	24	-	12	-	dB
Noise Figure [8]	RF/LO = 6 - 24 GHz Q = DC – 0.2 GHz	6	24	-	12	-	dB
Image Rejection [9]	RF/LO = 6 - 26 GHz I+Q = DC – 0.2 GHz	6	26	-	35	-	dBc
Input IP3 [10]	RF/LO = 6 - 26 GHz I = DC – 0.2 GHz	6	26	-	14	-	dBm
Amplitude Balance [11]	-	-	-	-	0.5	-	dB
Phase Balance	-	-	-	-	4	-	°
IF Frequency Range	-	-	-	0	-	6	GHz
Input 1 dB Gain Compression Point (P1dB), I	-	-	-	-	6	-	dBm
Input 1 dB Gain Compression Point (P1dB), Q	-	-	-	-	6	-	dBm
Q (Pin 10) Frequency Range	-	-	-	0	-	6	GHz
Isolation, LO to IF	IF/LO = 6 - 26 GHz	6	26	-	48	-	dB
Isolation, LO to RF	RF/LO = 6 - 26 GHz	6	26	-	39	-	dB
Isolation, RF to IF	RF/IF = 6 - 26 GHz	6	26	-	31	-	dB

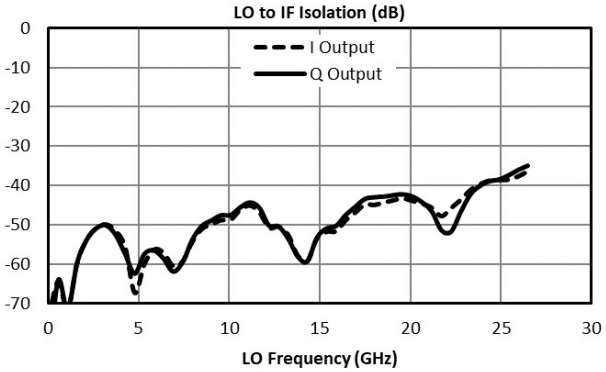
[1][2][3][4][5][6] Measured as an I/Q down converter. (i.e., I and Q powers are not combined)
[7] Mixer Noise Figure typically measures within 0.5 dB of conversion loss for IF frequencies greater than 5 MHz.
[8] Mixer Noise Figure typically measures within 0.5 dB of conversion loss for IF frequencies greater than 5 MHz.
[9] Image Rejection and Single sideband performance plots are defined by the upper sideband (USB) or lower sideband (LSB) with respect to the LO signal. Plots are defined by which sideband is selected by the external IF quadrature hybrid.
[10] Typical IIP3 measured with I and Q ports combined with an external quadrature hybrid coupler in a down conversion.
[11] Amplitude and phase balance measured in a down conversion.

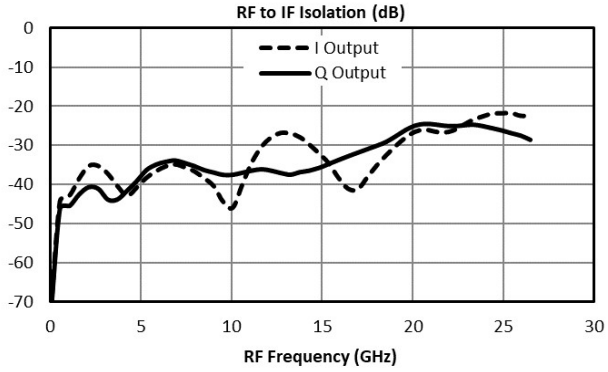
Typical Performance Plots

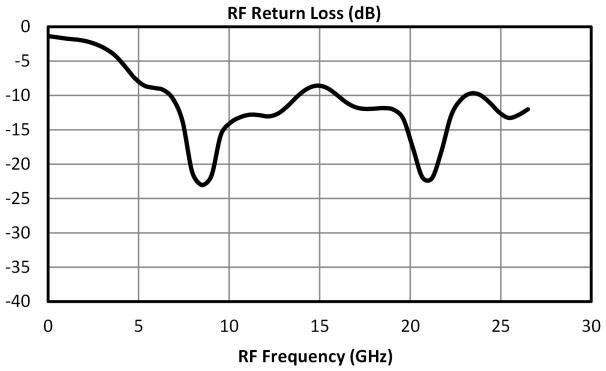
I output means that the IF output signal is measured at the I port of the mixer and the Q port is loaded. Q output means the IF output signal is measured at the Q port of the mixer while the I port is loaded.

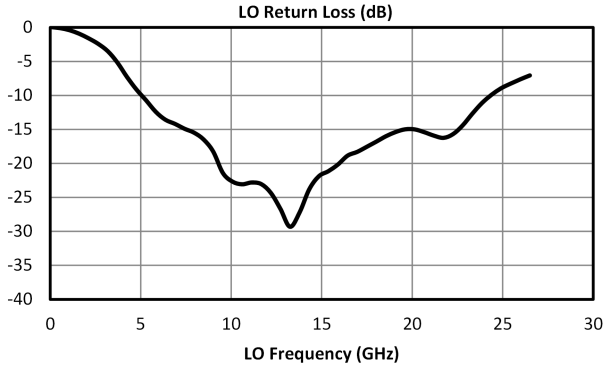


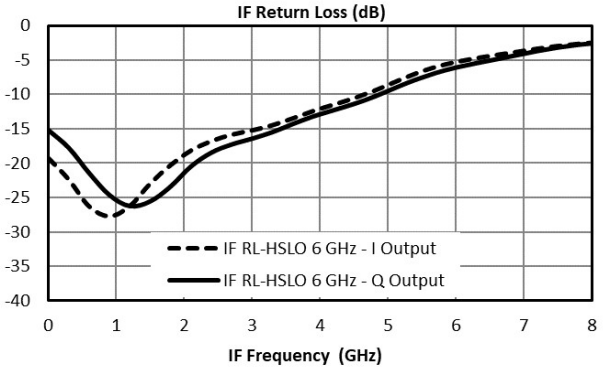


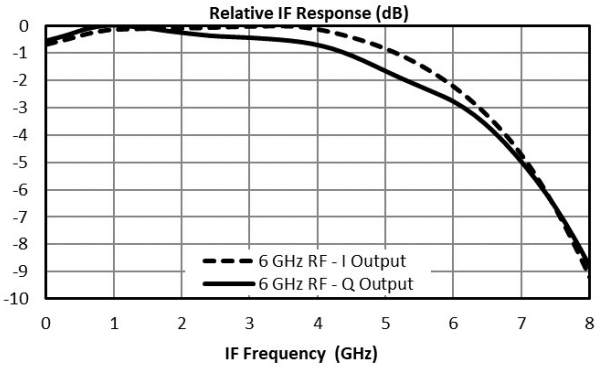


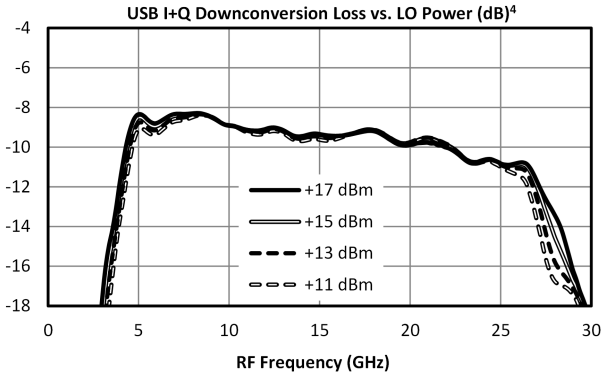


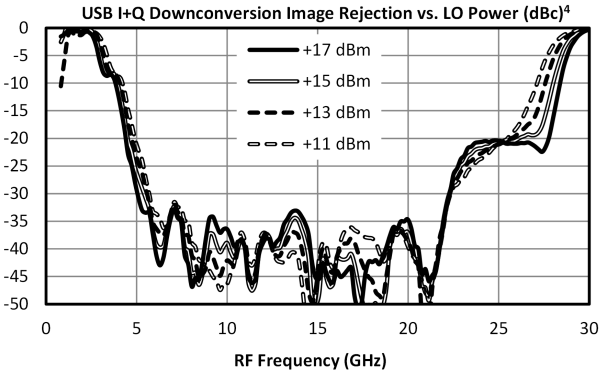


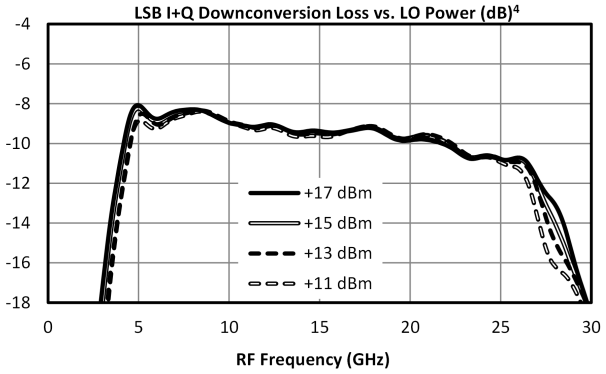


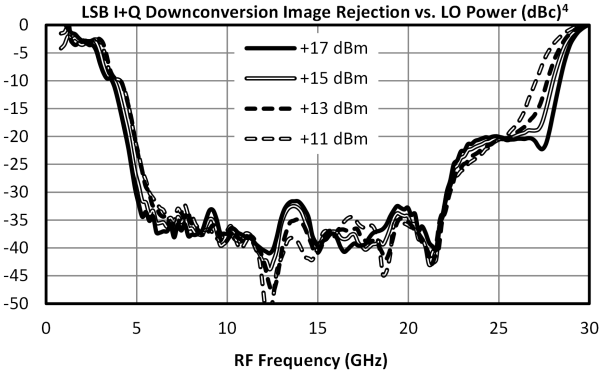




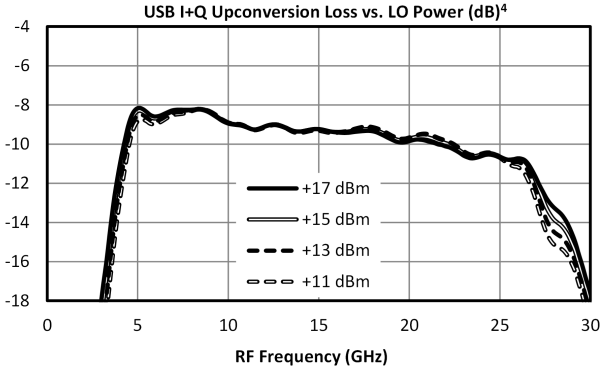




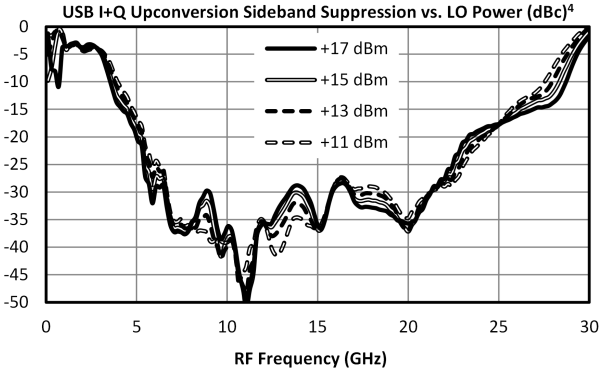




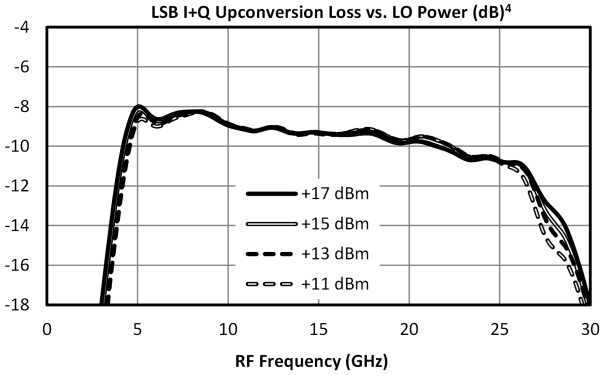
USB I+Q Upconversion Loss vs. LO Power (dB)[4]



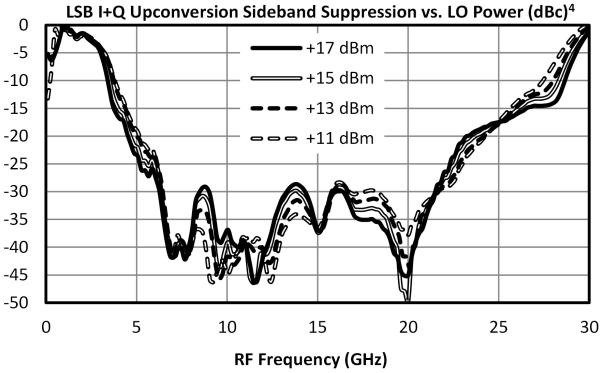
USB I+Q Upconversion Sideband Suppression vs. LO Power (dBc)[4]



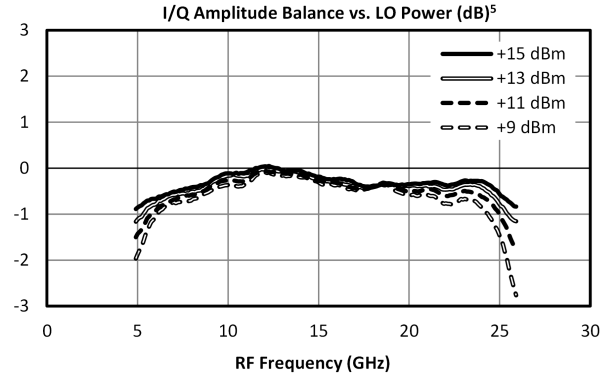
LSB I+Q Upconversion Loss vs. LO Power (dB)[4]



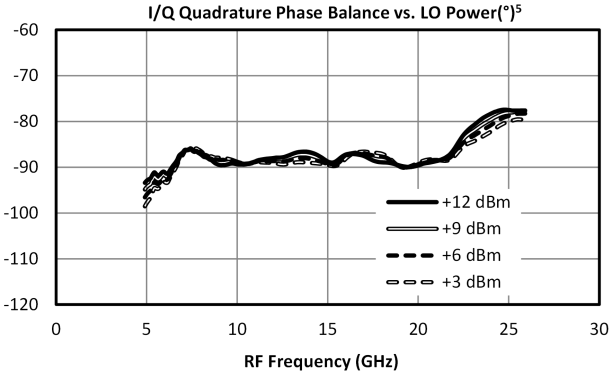
LSB I+Q Upconversion Sideband Suppression vs. LO Power (dBc)[4]

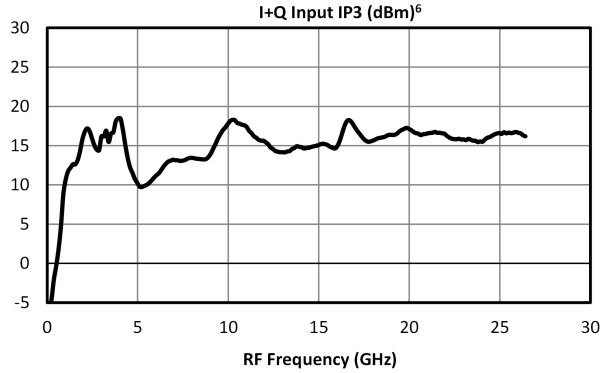


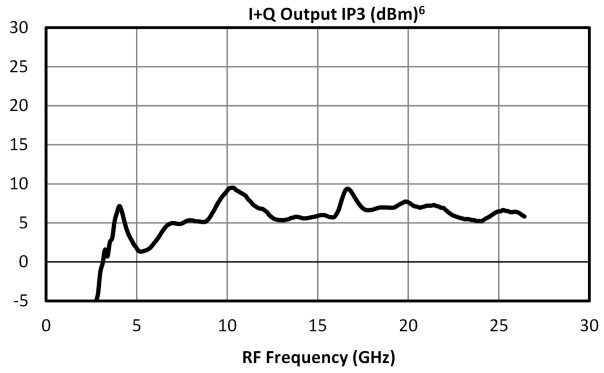
I/Q Amplitude Balance vs. LO Power (dB)[5]

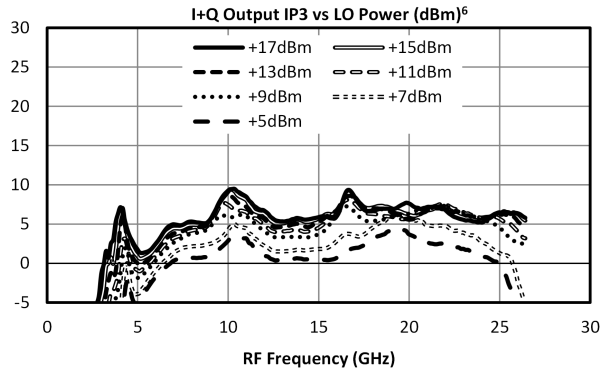


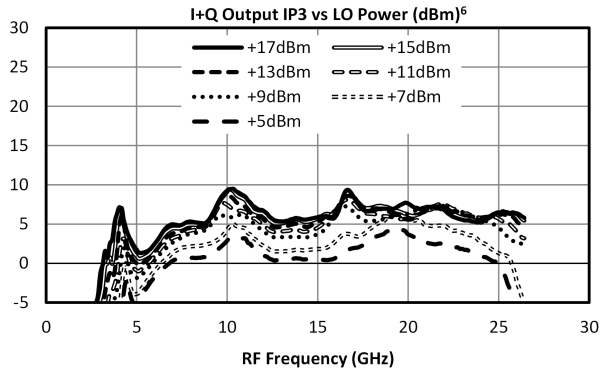
I/Q Quadrature Phase Balance vs. LO Power(°)[5]

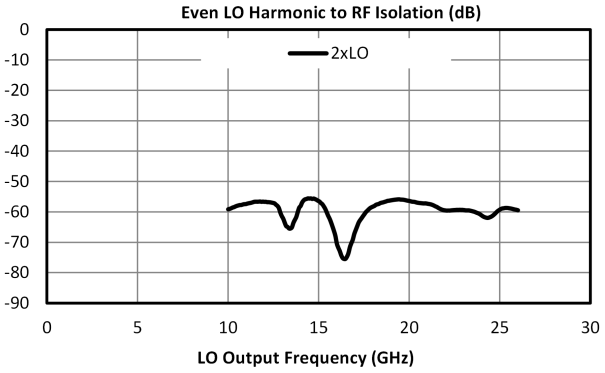


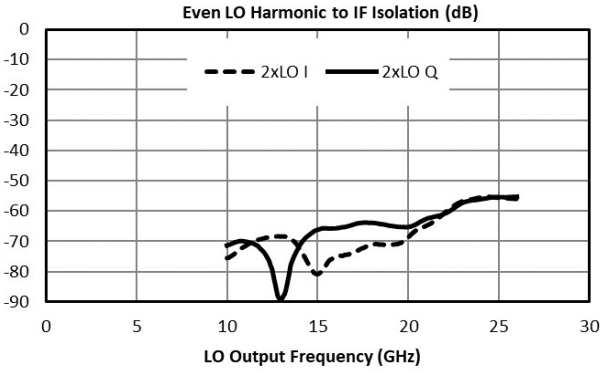


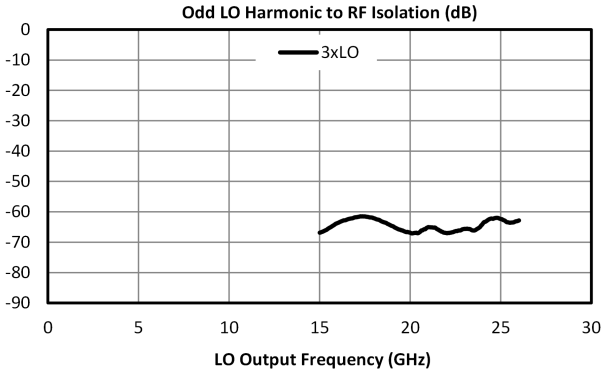


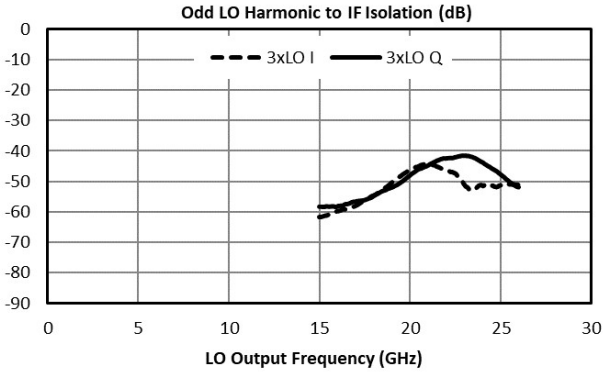












Spur Table

Typical Spurious Performance: Down-Conversion

Typical spurious data is provided by selecting RF and LO frequencies (± m*LO ± n*RF) within the RF/LO bands, to create a spurious output within the IF band. The mixer is swept across the full spurious band and the mean is calculated. The numbers shown in the table below are for a -10 dBm RF input. Spurious suppression is scaled for different RF power levels by (n-1), where “n” is the RF spur order. For example, the 2RF x 2LO spur is 64 dBc for a -10 dBm input, so a -20 dBm RF input creates a spur that is (2-1) x (-10 dB) lower, or 74 dBc. Data is shown for the frequency plan inTypical Performance.

Typical Down-conversion spurious suppression (dBc): Q Port (I Port)

-10 dBm RF Input	0xLO	1xLO	2xLO	3xLO	4xLO	5xLO
0xRF	-	48 (48)	65 (68)	50 (52)	N/A	N/A
1xRF	21 (21)	Reference	41 (32)	17 (10)	55 (44)	N/A
2xRF	72 (73)	47 (48)	64 (65)	57 (57)	67 (68)	59 (55)
3xRF	74 (73)	50 (51)	52 (57)	61 (62)	67 (69)	60 (61)
4xRF	N/A	69 (81)	69 (76)	77 (81)	89 (88)	87 (87)
5xRF	N/A	N/A	74 (81)	76 (80)	88 (93)	93 (93)

Typical Spurious Performance: Up-Conversion

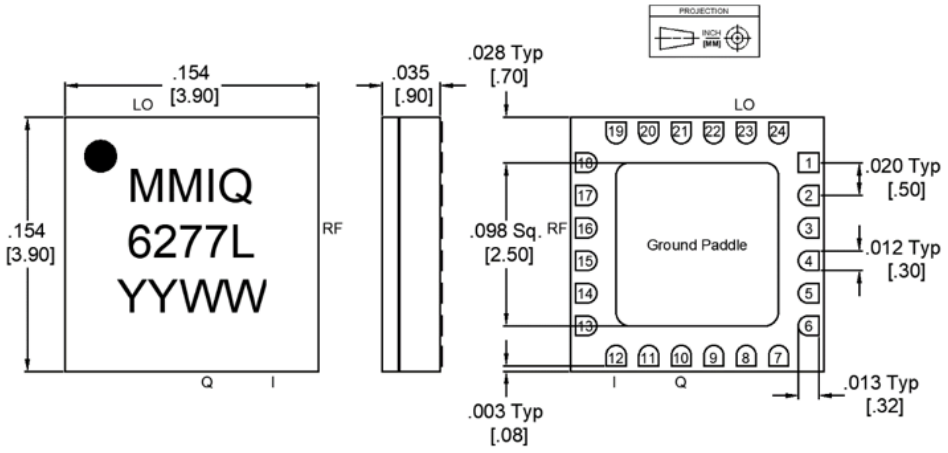
Typical spurious data is taken by mixing an input within the IF band, with LO frequencies (± m*LO ± n*IF), to create a spurious output within the RF output band. The mixer is swept across the full spurious output band and the mean is calculated. The numbers shown in the table below are for a -10 dBm IF input. Spurious suppression is scaled for different IF input power levels by (n-1), where “n” is the IF spur order. For example, the 2IFx1LO spur is typically 62 dBc for a -10 dBm input with a sine-wave LO, so a -20 dBm IF input creates a spur that is (2-1) x (-10 dB) lower, or 72 dBc. Data is shown for the frequency plan inTypical Performance.

Typical Up-conversion spurious suppression (dBc): Q Port (I Port)

-10 dBm RF Input	0xLO	1xLO	2xLO	3xLO	4xLO	5xLO
0xIF	-	39 (40)	60 (60)	64 (64)	N/A	N/A
1xIF	23 (21)	Reference	38 (33)	10 (9)	42 (42)	N/A
2xIF	70 (69)	62 (64)	53 (59)	67 (70)	50 (58)	58 (71)
3xIF	73 (74)	60 (61)	72 (72)	52 (55)	68 (71)	41 (46)
4xIF	94 (78)	91 (78)	81 (69)	92 (77)	78 (72)	83 (70)
5xIF	97 (77)	95 (75)	99 (79)	83 (68)	95 (76)	67 (54)

Mechanical Data

Outline Drawing



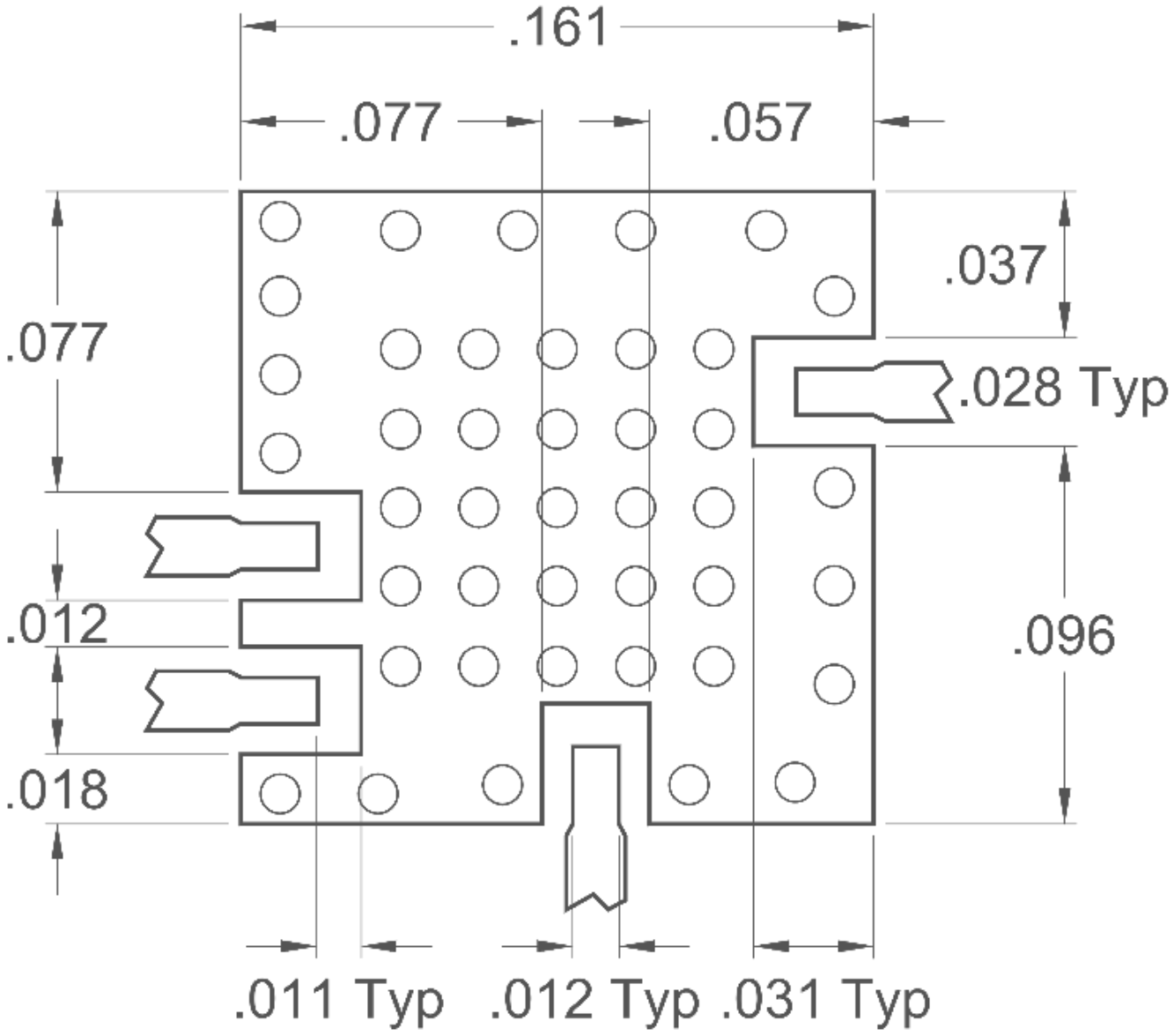
Pad #	Function
1	N/C
2	N/C
3	N/C
4	N/C
5	N/C
6	N/C
7	N/C
8	N/C
9	N/C
10	IF-Q
11	N/C
12	IF-I
13	N/C
14	N/C
15	N/C
16	RF
17	N/C
18	N/C
19	N/C
20	N/C
21	N/C
22	N/C
23	LO
24	N/C

1. Substrate material is ceramic.
2. I/O Leads and Ground Paddle plating is (from base to finish):

Ni:	8.89um MAX	1.27um MIN
Pd:	0.17um MAX	0.07um MIN
Au	0.254um MAX	0.03um MIN

3. All unconnected pads should be connected to PCB RF ground.

Footprint Image



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